



YOUSHANG SEMICONDUCTOR

设计研发新型功率器件

各类小信号开关

中低压及高压大电流等场效应管

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Features

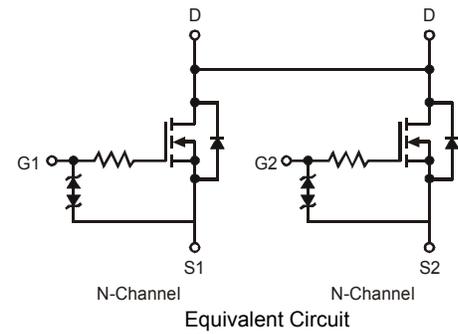
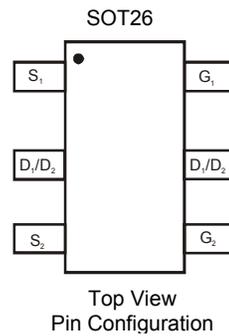
- Low Gate Charge
- Low $R_{DS(ON)}$:
 - $24m\Omega$ @ $V_{GS} = 4.5V$
 - $28m\Omega$ @ $V_{GS} = 2.5V$
 - $34m\Omega$ @ $V_{GS} = 1.8V$
- Low Input/Output Leakage

Mechanical Data

- Case: SOT26
- Case Material - Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 **(e3)**
- Terminal Connections: See Diagram
- Weight: 0.0008 grams (approximate)



Top View



Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	20	V
Gate-Source Voltage (Note 5)	V_{GSS}	± 12	V
Drain Current (Note 6) Continuous	I_D	$T_A = +25^\circ\text{C}$	6.5
		$T_A = +70^\circ\text{C}$	5.2
Pulsed Drain Current (Note 7)	I_{DM}	30	A

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

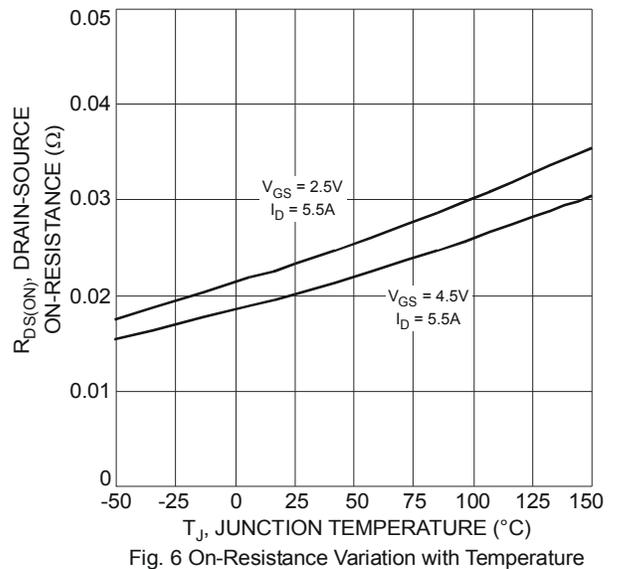
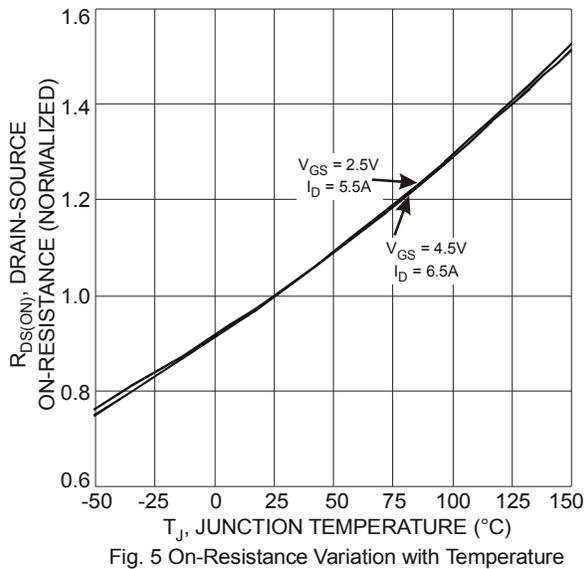
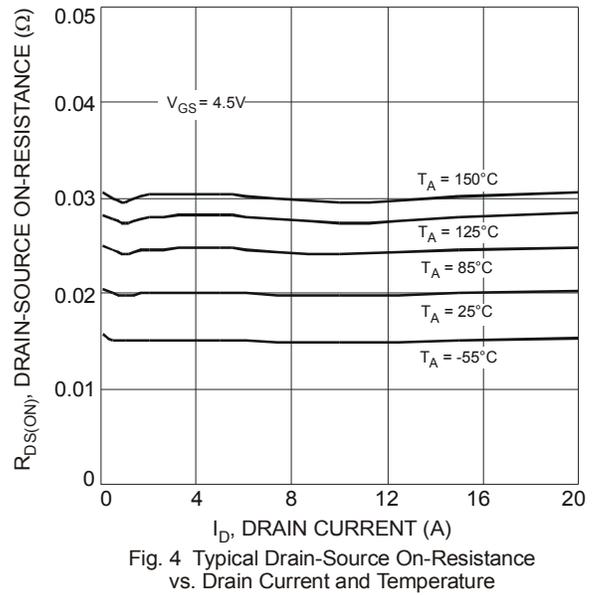
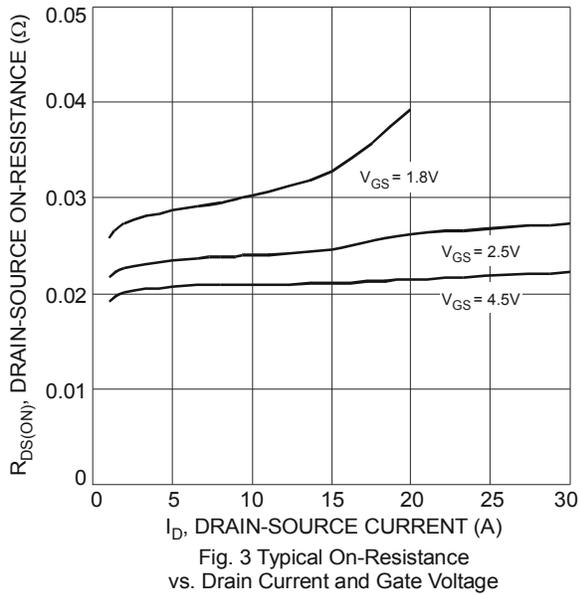
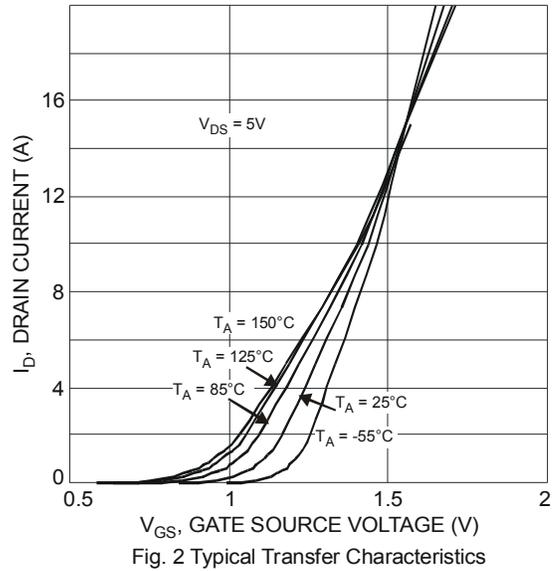
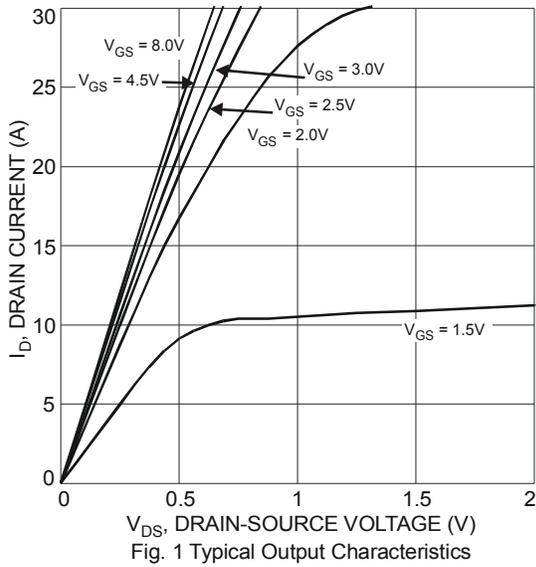
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	P_D	0.85	W
Thermal Resistance, Junction to Ambient (Note 6) $t \leq 10\text{s}$	$R_{\theta JA}$	147	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes:
- AEC-Q101 VGS maximum is $\pm 9.6\text{V}$.
 - Device mounted on 1"x1", FR-4 PC board with 2 oz. Copper and test pulse width $t \leq 10\text{s}$.
 - Repetitive Rating, pulse width limited by junction temperature.

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
STATIC CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	20	—	—	V	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1	μA	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$
Gate-Body Leakage Current	I_{GSS}	—	—	± 10	μA	$V_{DS} = 0\text{V}, V_{GS} = \pm 10\text{V}$
Gate-Source Breakdown Voltage	BV_{SGS}	± 12	—	—	V	$V_{DS} = 0\text{V}, I_G = \pm 250\mu\text{A}$
Gate Threshold Voltage	$V_{GS(th)}$	0.5	—	0.9	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
Static Drain-Source On-Resistance (Note 8)	$R_{DS(on)}$	—	17	24	m Ω	$V_{GS} = 4.5\text{V}, I_D = 6.5\text{A}$
			20	28		$V_{GS} = 2.5\text{V}, I_D = 5.5\text{A}$
			26	34		$V_{GS} = 1.8\text{V}, I_D = 3.5\text{A}$
Forward Transfer Admittance	$ Y_{FS} $	—	8	—	S	$V_{DS} = 10\text{V}, I_D = 5\text{A}$
Diode Forward Voltage (Note 8)	V_{SD}	—	0.7	1.0	V	$I_S = 2.25\text{A}, V_{GS} = 0\text{V}$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C_{iss}	—	143	—	pF	$V_{DS} = 10\text{V}, V_{GS} = 0\text{V}$ $f = 1.0\text{MHz}$
Output Capacitance	C_{oss}	—	74	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	29	—	pF	
Gate Resisistance	R_G	—	202	—	Ω	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$
SWITCHING CHARACTERISTICS (Note 9)						
Total Gate Charge	Q_g	—	8.8	—	nC	$V_{GS} = 4.5\text{V}, V_{DS} = 10\text{V}, I_D = 6.5\text{A}$
Gate-Source Charge	Q_{gs}	—	1.4	—	nC	
Gate-Drain Charge	Q_{gd}	—	3.0	—	nC	
Turn-On Delay Time	$t_{D(on)}$	—	53	—	ns	$V_{DD} = 10\text{V}, V_{GS} = 4.5\text{V},$ $R_L = 10\Omega, R_G = 6\Omega$
Turn-On Rise Time	t_r	—	78	—	ns	
Turn-Off Delay Time	$t_{D(off)}$	—	562	—	ns	
Turn-Off Fall Time	t_f	—	234	—	ns	

- Notes:
- Test pulse width $t = 300\text{ms}$.
 - Guaranteed by design. Not subject to production testing.



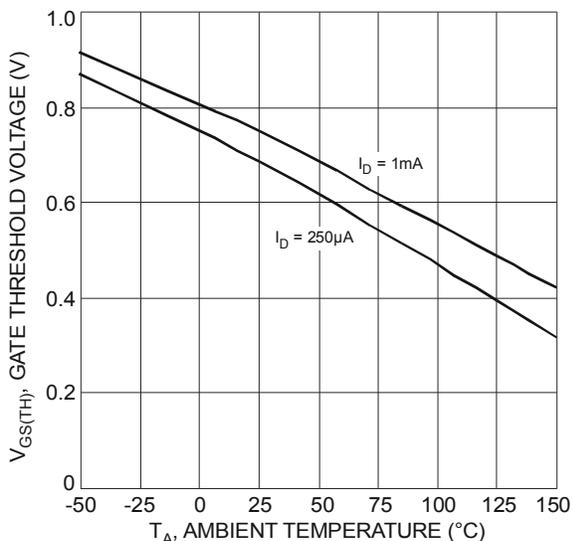


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

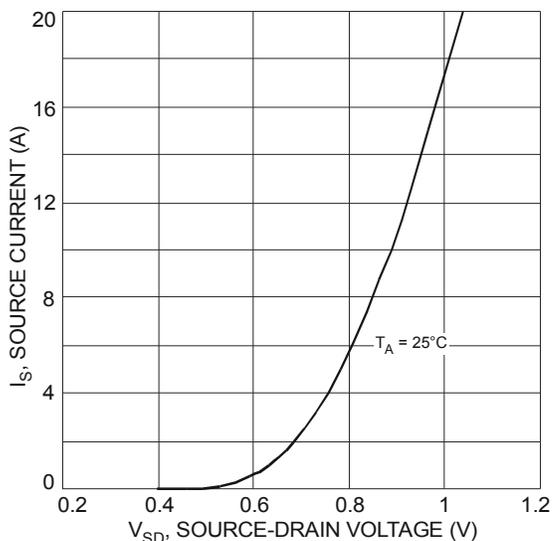


Fig. 8 Diode Forward Voltage vs. Current

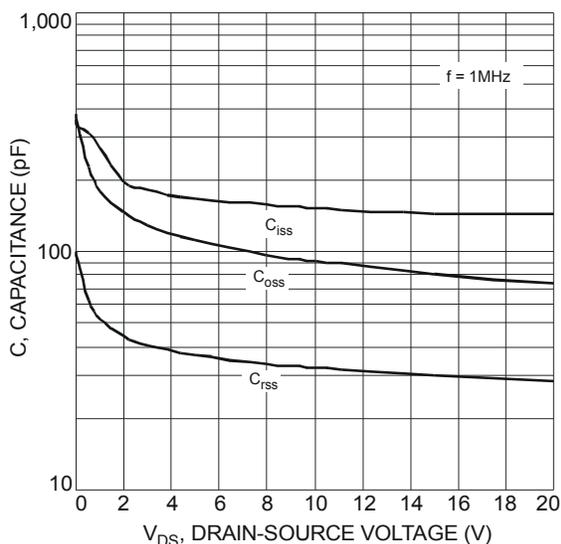


Fig. 9 Typical Capacitance

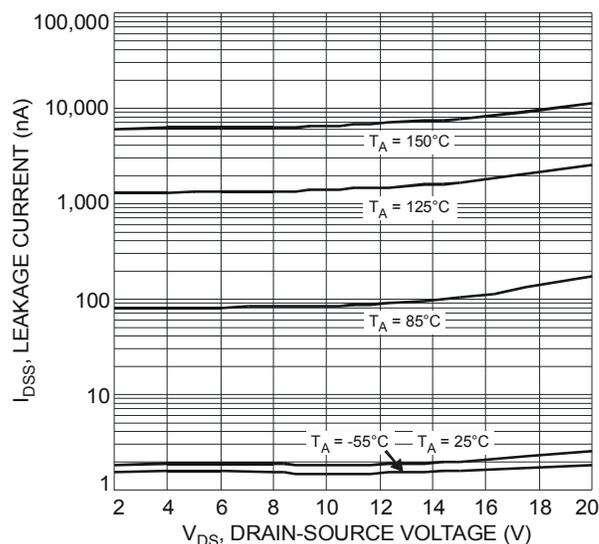
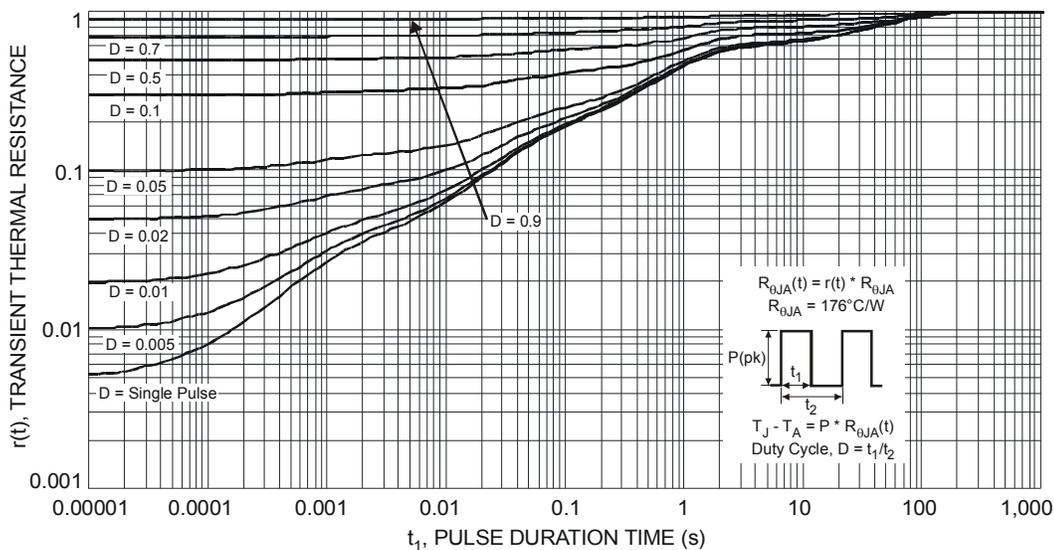
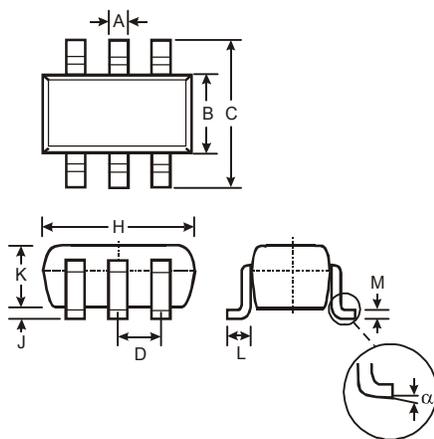


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage

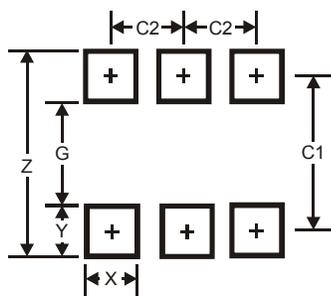


Package Outline Dimensions



SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95